



## Schottky Diodes

### Features

High frequency operation

Low forward voltage drop

High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance

Guard ring for enhanced ruggedness and long term reliability

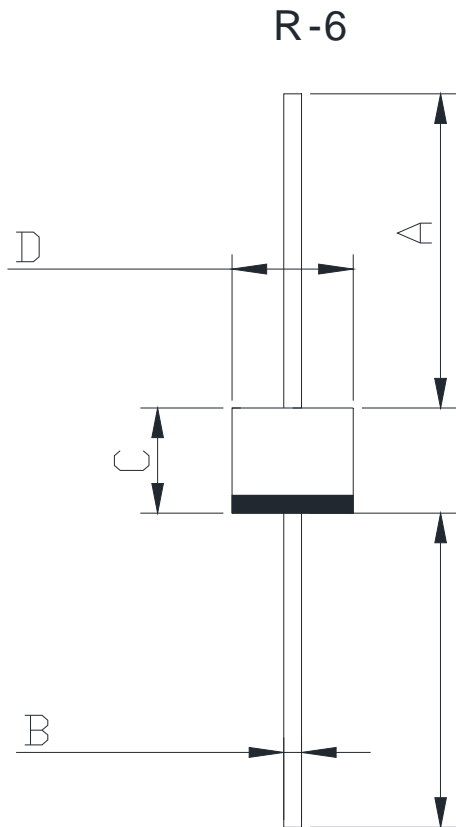
Solder dip 275 °C max. 7s, per JESD 22-B106

### Typical Applications





Outline Dimensions



R-6		
Dim	Min	Max
A	25.4	/
B	1.2	1.3
C	8.6	9.1
D	8.6	9.1



### Disclaimer

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